Introduction

The ISL6548A, in conjunction with the ISL6506, provides a complete ACPI compliant power solution for computer systems with either dual channel DDRI, DDRII, or DDRIII Memory systems. The chipset offered by Intersil provides the necessary control, protection and proper ACPI sequencing of the following rails: 5VDUAL, 3.3VDUAL, V_{DDQ_DDR}, V_{TT_DDR}, V_{DAC}, V_{GMCH}, and $V_{TT\_GMCH/CPU}$.

The ISL6548A consists of a synchronous buck controller to supply V_{DDQ_DDR} with high current during S0/S1 (Run) states and standby current during S3 (Suspend-To-RAM = STR) state. During Run mode, a fully integrated sink-source regulator generates an accurate ($V_{DDQ\_DDR}/2$) high current V_{TT_DDR} voltage. The ISL6548A also features a PWM controller that, in conjunction with an external gate driver IC, regulates V_{GMCH}. Two LDO controllers are available to regulate V_{DAC} and $V_{TT\_GMCH/CPU}$. The LDO for $V_{TT\_GMCH/CPU}$ is capable of sourcing and sinking current. A more complete description of the ISL6548A can be found in the datasheet[1].

The ISL6506 controls the 5VDUAL and 3.3VDUAL rails. There are three versions of the ISL6506. The version required will depend on whether 5V Dual is required to be active during S4/S5. A more complete description of the ISL6506 can be found in the datasheet[2].

Quick Start Evaluation

The ISL6548A_6506EVAL1Z board is shipped 'ready to use' right from the box. The ISL6548A_6506EVAL1Z supports testing with an ATX power supply. All seven outputs can be exercised through external loads. Both the V_{DDQ} and V_{TT} regulators have the ability to source or sink current while all other outputs may only source current.

There are posts available on each regulated output rail for drawing a load and/or monitoring the voltages. Eighteen individually labeled probe points are also available for use. These probe points provide Kelvin connections to signals which may be of interest to the designer.

Two switches have been placed on the board to accommodate ACPI signal simulation. These two switches generate the SLP_S3 and SLP_S5 signals that are sent to the ISL6506, ISL6548A and the ATX.

Recommended Test Equipment

To test the full functionality of the ISL6548A and ISL6506, the following equipment is recommended:

- An ATX power supply (minimum 160W configuration)
- Multiple electronic loads
- Four channel oscilloscope with probes
- Precision digital multimeters

As there are seven regulated rails, it is difficult to exercise and monitor all of them at the same time. The user may wish to employ discrete resistive loads in addition to electronic loads. Electronic loads are favored because they allow the user to apply a multitude of varying load levels and load transients which allow for a broader analysis.

Circuit Setup

SET SWITCHES

Ensure that the S3 switch is in the ACTIVE position and the S5 switch is in the S5 position. With the switches in these positions, the board will be forced into a sleep state at initial power up.

CONNECT THE ATX SUPPLY

Plug the 20-pin connector from the ATX power supply into the 20-pin receptacle, J1, on the evaluation board. Should the ATX power supply have a master AC switch, turn this switch to the OFF position prior to applying AC voltage.

CONNECT LOADS

Figure 1 details the locations of the available power, ground, and signal connection points on the ISL6548A_6506EVAL1Z evaluation board. The maximum loads specified for each rail below are absolute. V_{TT_DDR} is cascaded from the V_{DDQ_DDR} rail while the $V_{TT\_GMCH/CPU}$ is cascaded from the V_{GMCH} rail (refer to "ISL6548A_6506EVAL1Z Schematic" on page 11). Any loading of a cascaded rail will itself be a load on the rail that is providing input and must be accounted for prior to application of loads.
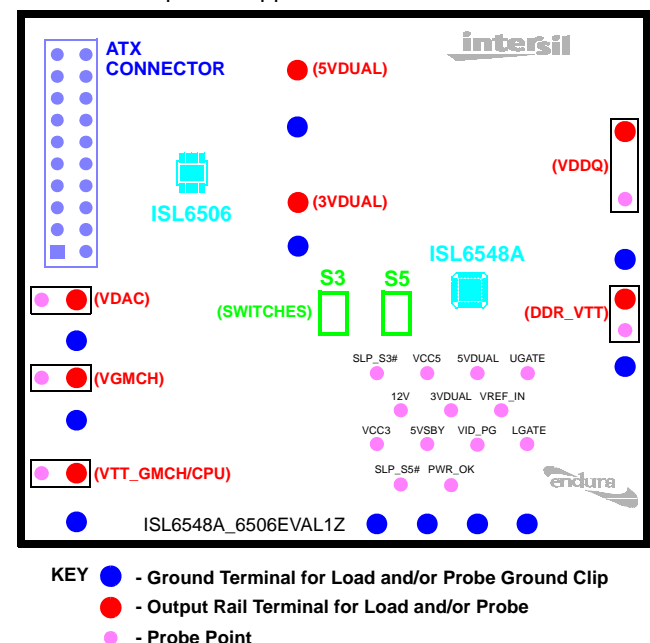

FIGURE 1. ISL6548A_6506EVAL1Z BOARD POWER AND SIGNAL CONNECTIONS

Loading V$_{DDQ\_DDR}$ - Sourcing Current: Connect the positive terminal of an electronic load to the VDDQ post. Connect the return terminal of the same load to the corresponding GND post. The maximum load current that the rail will support prior to entering an over-current condition is 15A.

Loading V$_{DDQ\_DDR}$ - Sinking Current: Typically, the V$_{DDQ}$ rail does not sink current, however, the ISL6548A has the ability to allow the V$_{DDQ}$ rail to do just that. To test the V$_{DDQ}$ rail while sinking current, connect the positive terminal of an electronic load to the 5VDUAL post. Connect the return terminal of the same load to the VDDQ post. The maximum load current that the rail will support prior to entering an over-current condition is 15A.

CAUTION: The return terminal of the load must float for this to work properly.

Loading V$_{TT\_DDR}$ - Sourcing Current: To test V$_{TT\_DDR}$ while the regulator sources current, connect the positive terminal of an electronic load to the DDR_ VTT post. Connect the return terminal of the same load to the corresponding GND post. The maximum continuous current that the rail will support is 2A. Transient loads to 3A are also supported.

Loading V$_{TT\_DDR}$ - Sinking Current: To test V$_{TT\_DDR}$ while the regulator sinks current, connect the positive terminal of an electronic load to the VDDQ post. Connect the return terminal of the same load to the DDR_VTT post. The maximum continuous current that the rail will support is 2A. Transient loads to 3A are also supported.

CAUTION: The return terminal of the load must float for this to work properly.

Loading V$_{GMCH}$: Connect the positive terminal of an electronic load to the VGMCH post. Connect the return terminal of the corresponding GND post. The maximum load supported by this rail is 10A.

Loading V$_{DAC}$: Connect the positive terminal of an electronic load to the VDAC post. Connect the return terminal of the corresponding GND post. The maximum load supported by this rail is 5A.

Loading V$_{TT\_GMCH/CPU}$ - Sourcing Current: Connect the positive terminal an electronic load to the VTT_GMCH/CPU post. Connect the return terminal of the corresponding GND post. The maximum load supported by this rail is 5A.

Loading V$_{TT\_GMCH/CPU}$ - Sinking Current: To test V$_{TT\_GMCH/CPU}$ while the regulator sinks current, connect the positive terminal of an electronic load to the VGMCH post. Connect the return terminal of the same load to the VTT_GMCH/CPU post. The maximum continuous current that the rail will support is 5A.

CAUTION: The return terminal of the load must float for this to work properly.

Loading 5VDUAL: Connect the positive terminal of an electronic load to the 5VDUAL post. Connect the return terminal of the corresponding GND post. The maximum load supported by this rail is 14A.

Loading 3VDUAL: Connect the positive terminal of an electronic load to the 3VDUAL post. Connect the return terminal of the corresponding GND post. The maximum load supported by this rail is 14A.

Operation

APPLY POWER TO THE BOARD

Plug the ATX supply into the mains. If the supply has an AC switch, turn it on. With the S3 and S5 switches in the ACTIVE and S5 positions, respectively, the board will be in the S5 sleep state. Voltages present on the board will be 5VSBY which is supplied by the ATX and 3VDUAL which is controlled by the ISL6506.

To enable the circuit, toggle the S5 switch to ACTIVE. This will place the board in the S0 state. All outputs should be brought up.

EXAMINE START-UP WAVEFORMS AND OUTPUT QUALITY UNDER VARYING LOADS

Start up is immediate following the transition to the S0 state. Using an oscilloscope or other laboratory equipment, the ramp-up and/or regulation of the outputs can be studied. Loading of the output can be accomplished through the use of an electronic load. Other methods, such as the use of discrete power resistors will work for loading as well.

Reference Design

General

The ISL6548A_6506EVAL1Z is an evaluation board that highlights the operation of the ISL6548A and ISL6506 in an embedded ACPI and DDR DRAM Memory Power application. The V$_{DDQ\_DDR}$ supply has been designed to supply 1.8V at a maximum load of 15A. The V$_{TT\_DDR}$ termination supply will track the V$_{DDQ\_DDR}$ supply at 50% while sourcing or sinking current. The second PWM controller is designed to supply up to 10A of current at 1.5V for V$_{GMCH}$ while the single stage LDOs supply 2.5V for V$_{DAC}$ and 1.2V for V$_{TT\_GMCH/CPU}$. Refer to "ISL6548A_6506EVAL1Z Schematic" on page 11, "ISL6548A_6506EVAL1Z Bill of Material" on page 12 and "ISL6548A_6506EVAL1Z Layout" on page 13).

Power Up And State Transitions

Sleep State Transitions

There are several distinct state transitions that the ISL6548A and ISL6506 support. These include a Cold/Mechanical Start (S5 to S0 state transition), Active to Sleep (S0 to S3 transition), Sleep to Active (S3 to S0 transition) and finally

Active to Shutdown (S0 to S5 transition). Table 1 shows the switch positions and the corresponding ACPI states.

TABLE 1. ISL6548A_6506EVAL1Z STATES

S3 SWITCH	S5 SWITCH	SLEEP STATE	ATX STATE
ACTIVE	ACTIVE	S0 (Active)	ON
S3	ACTIVE	S3	Standby
ACTIVE	S5	S5	Standby
S3	S5	S5	Standby

If both the S3 and S5 switches are thrown to S3 and S5, respectively, the board will default to an S5 state. If the board is in either an S3 or S5 sleep state, the ATX supply is put into standby mode, where only the 5VSBY rail is active.

Initial Power Up - Cold Start

If both the S3 and S5 switches are toggled to the ACTIVE position prior to applying AC power to the ATX supply, the board will immediately enter into S0 state when the 5VSBY rail comes up after the AC power is applied to the ATX. Figure 2 shows a Cold Start. Examination of the V_{DAC}
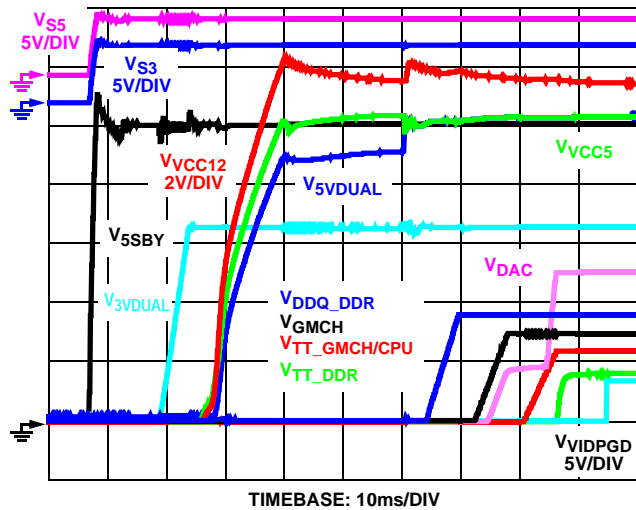

TIMEBASE: 10ms/DIV
NOTE: ALL SIGNALS AT 1V/DIV UNLESS OTHERWISE STATED
FIGURE 2. COLD/MECHANICAL START

waveform shows this rail ramping up with the V_{GMCH} rail. This is due to an external circuit that was included on the evaluation board and is described in the section titled "Grantsdale VDAC Sequencing Circuitry" on page 5.

S5 Sleep State to S0 State Transition

If the S5 switch is toggled to the S5 position prior to application of AC power to the ATX supply, then the board will immediately enter into the S5 sleep state when the 5VSBY rail comes up after the AC voltage is applied to the ATX. The ISL6506 will bring up the 3VDUAL rail but all other output rails will be inactive. The transition from the S5 state to the S0 state will occur when the S5 switch is toggled to the

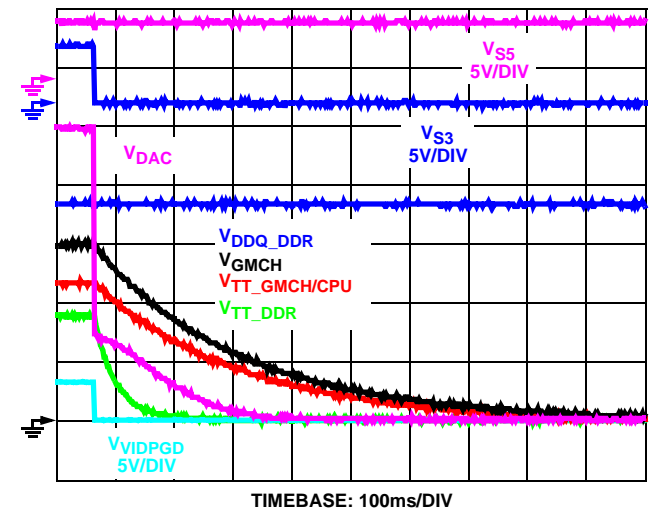ACTIVE position. Figure 3 shows this transition. Note that
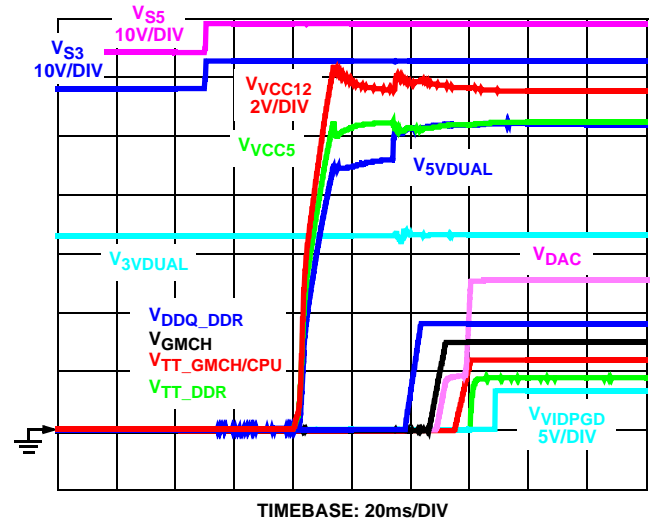
TIMEBASE: 20ms/DIV
NOTE: ALL SIGNALS AT 1V/DIV UNLESS OTHERWISE STATED
FIGURE 3. S5 TO S0 STATE TRANSITION

the 3VDUAL rail are already active prior to the other rails soft starting. If the ISL6506A had been used, the 5VDUAL rail would have been active in the S5 state as well. During testing of the evaluation board, it may be observed that the 5VDUAL rail stays up during the S5 sleep state. If this behavior is observed, the explanation would be that the bulk capacitor on the 5VDUAL rail did not discharge a significant amount while the board was in the S5 sleep state.

S0 to S3 Sleep State Transition

Figure 4 shows the transition from the S0 state to the S3 sleep state. To achieve this transition, switch S3 is toggled to the S3 position. When transitioning from the S0 state to the S3 sleep state, it is important that the load on the V_{DDQ_DDR} rail be reduced to levels that the 5VDUAL rail is capable of supporting. If the load on V_{DDQ_DDR} is excessive, V_{DDQ_DDR} voltage will collapse.

TIMEBASE: 100ms/DIV
NOTE: ALL SIGNALS AT 500mV/DIV UNLESS OTHERWISE STATED
FIGURE 4. S0 TO S3 STATE TRANSITION

S3 to S0 State Transition

Figure 5 shows the transition from the S3 sleep state to the S0 state. This transition is accomplished by returning the S3 switch to the ACTIVE position. Once the PGOOD signal has been asserted, the V_{DDQ_DDR} rail can then be loaded beyond the S3 load limitations of 5VDUAL.
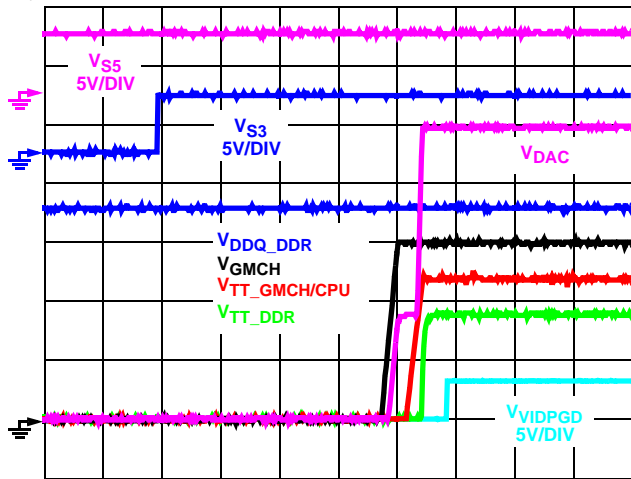
TIMEBASE: 20ms/DIV
NOTE: ALL SIGNALS AT 500mV/DIV UNLESS OTHERWISE STATED
FIGURE 5. S3 TO S0 STATE TRANSITION

ACPI Start Up Timing

The ISL6506 and ISL6548A chipset were designed to work in tandem to start up critical ACPI and Memory voltages within a specific window of opportunity during the overall start up or sleep recovery process of a typical motherboard. Figure 6 shows a generic desktop sleep state to wake state sequencing. At time T1, either the SLP_S3# or SLP_S5#
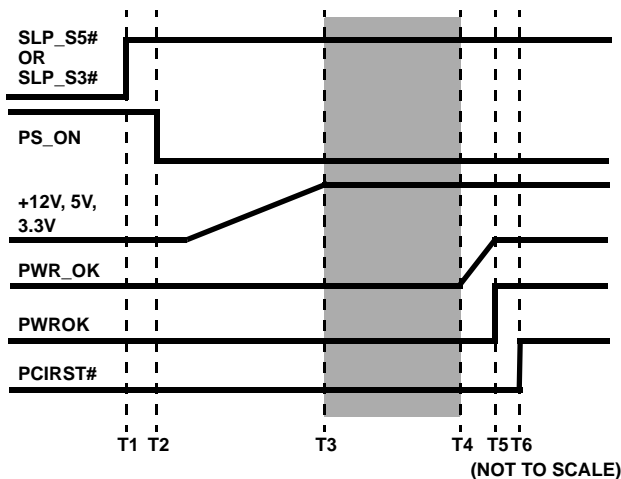

FIGURE 6. GENERIC WAKEUP SEQUENCING

signal transitions HIGH, which is the signal to the system to enter into the S0 state. At time T2, 10ns later, PS_ON, the signal that commands the ATX supply to turn on, is forced LOW. At time T3, the ATX rails have risen to 95% of their targeted nominal levels. The time between T2 and T3 can be between 100ms and 500ms. At time T4, the PWR_OK signal from the ATX supply starts to rise. The time between T3 and

T4 will also fall between 100ms and 500ms. At time T5, the ATX PWR_OK signal has risen HIGH. This transition is specified to be less than 10ms. At this point, the PWROK signal from the GMCH is commanded HIGH. At time T6, anywhere from 31 to 44 RTCs after PWROK has asserted HIGH, the PCIRST# signal from the ICH asserts HIGH. When PCIRST# asserts HIGH, bus traffic resumes and the system is awake.

The ISL6506 and ISL6548A chipset bring all the ACPI rails under their control into regulation between time T3 and T4. This timing assures, even with minimum specified system timings, that the regulators will have their inputs available from the ATX supply and also that the output rails will be in regulation and ready for bus traffic once PCIRST# asserts HIGH.[4], [5]

Evaluation Board Design

The complete Bill of Material for the evaluation board can be seen in "ISL6548A_6506EVAL1Z Bill of Material" on page 12. This section gives an overview of the design parameters and decisions made for each regulator.

ISL6506 Circuitry

The ISL6506 incorporates all the ACPI timing, control and monitoring required for the 5VDUAL and 3.3VDUAL rails, while maintaining a low component count. The Vishay Si7840 was utilized for both N-Channel MOSFET pass elements due to the low $r_{DS(ON)}$ and thermal capabilities of the packaging. Very little power is dissipated from the MOSFET in this application. The P-Channel MOSFET, the Vishay Si7483, was chosen for similar reasons.

The MOSFET thermal capabilities and it's $r_{DS(ON)}$ are the two major considerations when choosing a MOSFET as a pass element for the 5VDUAL and 3.3VDUAL rails. The maximum allowable temperature rise of the MOSFET is used to calculate the maximum power that the MOSFET can dissipate via the thermal resistance ratings of the FET. The maximum $r_{DS(ON)}$ of the MOSFET can then be calculated by dividing the maximum allowable power dissipation of the MOSFET by the square of the maximum load current that will flow through the MOSFET. If the datasheet specified $r_{DS(ON)}$ of the MOSFET being considered is less than this calculated maximum $r_{DS(ON)}$ value, then the MOSFET can be used safely in the application, provided proper layout techniques for thermal dissipation are used.

ISL6548A Circuitry

V_{DDQ_DDR} SWITCHING REGULATOR

The V_{DDQ_DDR} switching regulator was designed to handle a 15A continuous output load while maintaining 1.8V. Voltage excursions due to transient loading of 25A/µs were to be no greater than 50mV with a full 15A load step.

In order to supply 15A of continuous current, two upper and two lower MOSFETs were utilized. The part chosen for both

upper and lower MOSFETs was the Vishay Si7840BDP. The choice of both the MOSFET and the parallel MOSFET configuration will actually allow for a continuous current of at least 20A without the FETs becoming too hot.

The transient specifications were met by employing large value capacitors that have relatively low ESR ratings and by using some ceramic capacitors to decrease the effective ESR even more. Three 1800µF bulk capacitors with 16mΩ ESR were utilized as the bulk output capacitance. During a transient, the large capacitance supplies energy to the load while the output inductor current slews up to match the load current.

The output inductor was designed so that the ripple voltage on the output rail would be approximately 20mV. A simple wirewound toroidal inductor was designed for this regulator. To save on the Bill of Material (BoM) cost, the same inductor was used on the input filter to the V_{DDQ} regulator.

Since there is an input inductor, the input capacitors must be rated to handle all of the AC RMS current going through the upper MOSFET. The capacitors that were chosen have RMS current ratings that exceed the maximum RMS current expected at full load.

The final aspect to the V_{DDQ_DDR} regulator design was to insure the stability of the system. A Type III compensation network was chosen for this design. The compensation components were calculated to give a system bandwidth of about 50kHz with a Phase Margin of approximately 65°. For more information on calculating the compensation components for a single phase buck regulator, see Intersil's Technical Brief, TB417, titled "Designing Stable Compensation Networks for Single Phase Voltage Mode Buck Regulators."[3]

V_{GMCH} SWITCHING REGULATOR

The regulation of the V_{GMCH} rail is accomplished by down converting from the 3.3VATX rail with a switching regulator. The ISL6548A incorporates all the control aspects of the switching regulator and requires that a MOSFET gate driver be utilized to drive the upper and lower MOSFETs of the synchronous buck switching regulator. This design utilizes the ISL6613 to drive the switching MOSFETs. The MOSFETs chosen were dual packaged FETs from Vishay, the Si7844. The FETs and the package allow for efficient regulation at full load of 10A. The output inductor is the same as the input and output inductor used in the V_{DDQ} regulator. The output capacitor allows for a large amount of capacitance while minimizing the output ripple to less than 40mV. The compensation network is a Type III. This network yields a stable system with approximately 30kHz of bandwidth.

LDO REGULATORS

The V_{TT_DDR} regulator required minimal design work as the control circuitry and pass element are incorporated within the ISL6548A. Except for the pass element and output capacitance, all other circuitry for the remaining LDOs is also contained within the ISL6548A.

The V_{DAC} and $V_{TT\_GMCH/CPU}$ are both regulated via the internal LDO controllers. The pass elements chosen for both was the Vishay Si7840BDP. This allowed for a higher single part count on the BoM while allowing the regulators to source a sufficient amount of load.

For all the LDOs, including the V_{TT_DDR} regulator, the output capacitance was chosen to maintain a stable output rail while minimizing voltage excursions due to load transients.

GRANTSDALE VDAC SEQUENCING CIRCUITRY

The Grantsdale chipset imposes special requirements on the startup and shutdown timing of the V_{DAC} rail in relation to the V_{GMCH} rail. During start up, the V_{DAC} rail must not start up until the V_{GMCH} rail has reached at least 0.7V. When entering a sleep state, the V_{DAC} rail must be brought below the V_{GMCH} rail level before the V_{GMCH} rail can begin to ramp down.

A circuit was included on the ISL6548A evaluation board that will keep a 0.7V differential between the V_{GMCH} and V_{DAC} rails until the V_{DAC} rail is soft started. This circuit will also discharge the V_{DAC} rail immediately upon entering into a sleep state. This circuit is shown in Figure 7. During start-
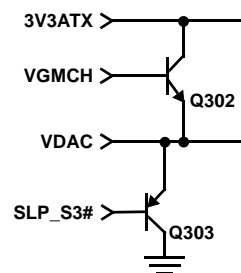

FIGURE 7. GRANTSDALE SEQUENCING CIRCUITRY

up, the base-emitter junction of Q302 maintains a 0.7V differential between V_{GMCH} and V_{DAC}. Upon assertion of the SLP_S3# signal, Q303 discharges the V_{DAC} rail which allows the V_{GMCH} rail to discharge.

Evaluation Board Performance

This section presents the performance of the ISL6548A_6506EVAL1Z evaluation board while subjected to various conditions.

Switching Regulator Ripple Voltages

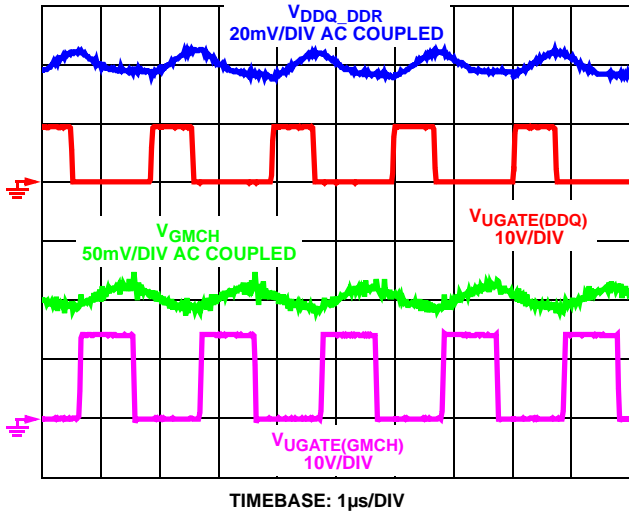Figure 8 shows the ripple voltage on the V_{DDQ} and V_{GMCH} outputs.

TIMEBASE: 1µs/DIV
FIGURE 8. V_{DDQ} and V_{GMCH} RIPPLE VOLTAGE

Transient Performance

Figures 9, 10, 11, 12, 13 and 14 show the response of the outputs when subjected to a variety of transient loads while in the Active (S0) State. Figure 9 shows V_{DDQ_DDR} under transient loading. The response of the V_{DDQ_DDR} regulator to the transient load brings the output voltage back into regulation very quickly.
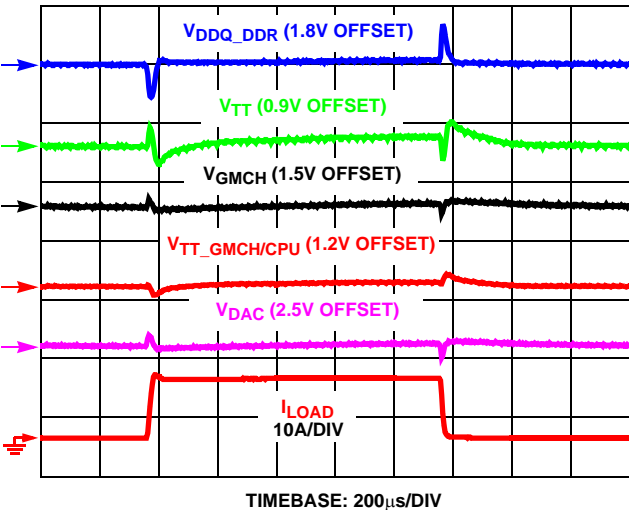
TIMEBASE: 200µs/DIV
NOTE: ALL SIGNALS AT 50mV/DIV UNLESS OTHERWISE STATED
FIGURE 9. TRANSIENT ON V_{DDQ}

Figure 10 shows V_{TT_DDR} under a transient loading that causes V_{TT_DDR} to source current.
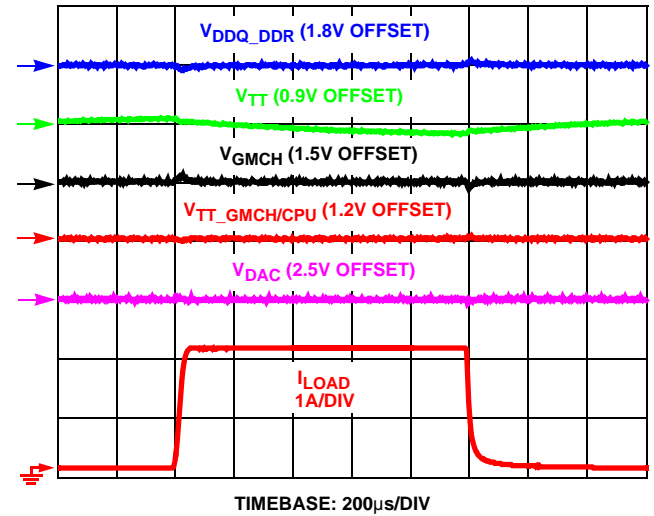
TIMEBASE: 200µs/DIV
NOTE: ALL SIGNALS AT 50mV/DIV UNLESS OTHERWISE STATED
FIGURE 10. SOURCING TRANSIENT ON V_{TT_DDR}

While the load is being applied to the V_{TT_DDR} rail, there is a noticeable reaction in the V_{DDQ_DDR} rail as well. Since the V_{TT_DDR} rail is derived from the V_{DDQ_DDR} rail, any load on the V_{TT_DDR} rail is seen by the V_{DDQ_DDR} rail.

Figure 11 shows V_{TT_DDR} under a transient that causes V_{TT_DDR} to sink current.
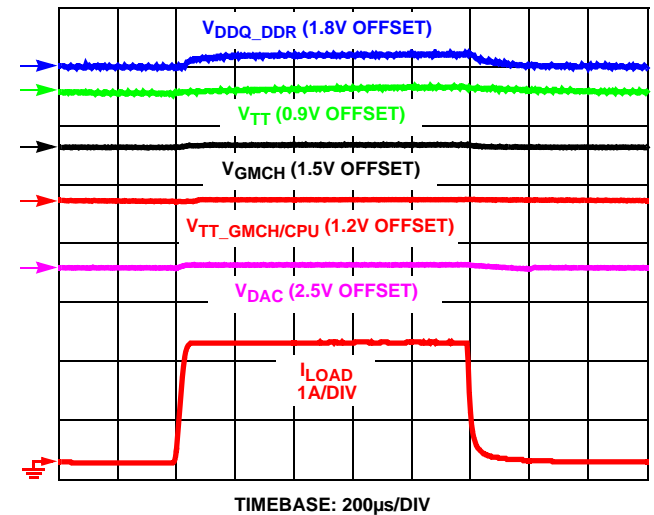

TIMEBASE: 200µs/DIV
NOTE: ALL SIGNALS AT 50mV/DIV UNLESS OTHERWISE STATED
FIGURE 11. SINKING TRANSIENT ON V_{TT_DDR}

Again, the reaction of the V_{DDQ_DDR} rail is evident since the loading on the V_{TT_DDR} rail is transferred directly to the V_{DDQ_DDR} rail. In both cases, sourcing and sinking current, where the V_{TT_DDR} rail has been loaded and the V_{DDQ_DDR} rail has responded to the loading, the V_{TT_DDR} rail did not appear to be affected as much as the V_{DDQ_DDR} rail. This is because a linear regulator (V_{TT_DDR}) will respond much faster than a switching regulator (V_{DDQ_DDR}). This difference in response is because the

inductor current must slew up/down to supply the load current while the linear regulator control will apply more voltage to the gate of the pass FET.
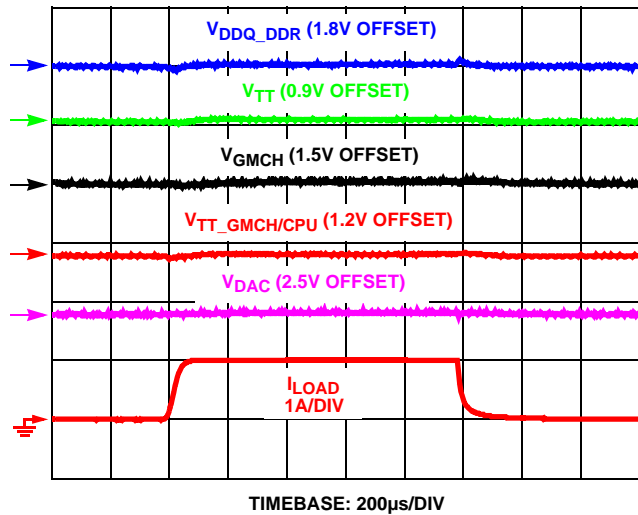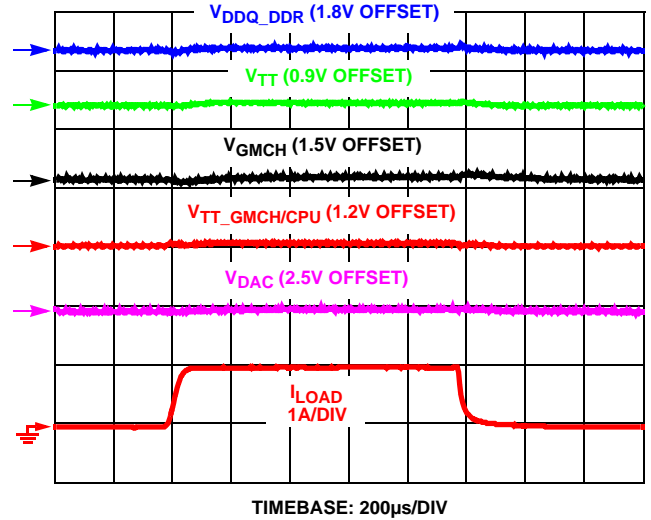
Figure 12 shows V$_{GMCH}$ under transient loading.
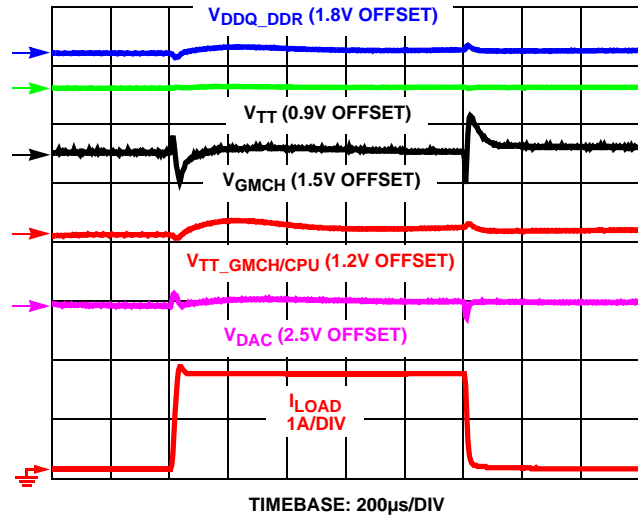
TIMEBASE: 200µs/DIV
NOTE: ALL SIGNALS AT 50mV/DIV UNLESS OTHERWISE STATED
FIGURE 12. TRANSIENT ON V$_{GMCH}$

The response of the V$_{GMCH}$ regulator to the transient load brings the output voltage back into regulation very quickly. The V$_{TT\_GMCH/CPU}$ rail is affected by the transient on the V$_{GMCH}$ rail since it is derived from the V$_{GMCH}$ rail.

Figure 13 shows the V$_{TT\_GMCH/CPU}$ rail under a sourcing transient load. Figure 14 shows the V$_{TT\_GMCH/CPU}$ rail under a sourcing transient load.
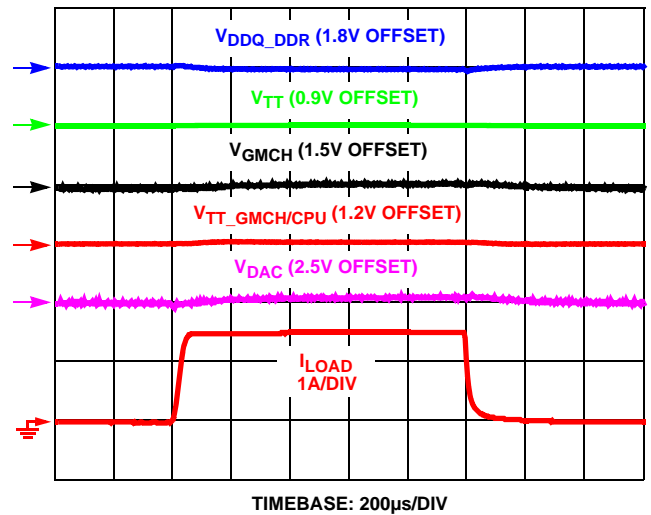

TIMEBASE: 200µs/DIV
NOTE: ALL SIGNALS AT 50mV/DIV UNLESS OTHERWISE STATED
FIGURE 13. SOURCING TRANSIENT ON V$_{TT\_GMCH/CPU}$

TIMEBASE: 200µs/DIV
NOTE: ALL SIGNALS AT 50mV/DIV UNLESS OTHERWISE STATED
FIGURE 14. SINKING TRANSIENT ON V$_{TT\_GMCH/CPU}$

The loading of this rail is light enough such that the response of the V$_{GMCH}$ rail is negligible.
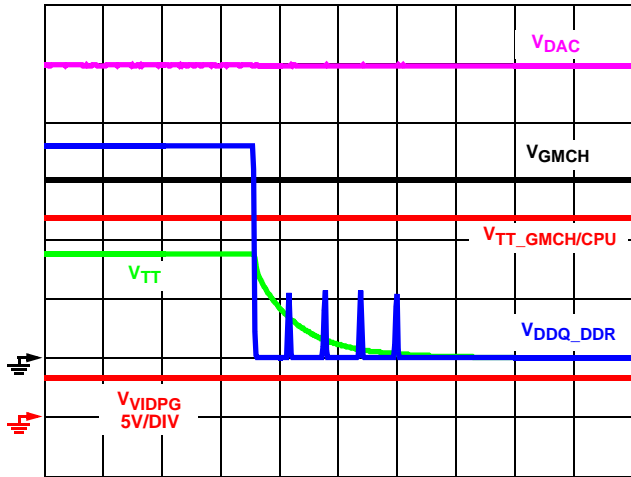
Figure 15 shows the V$_{DAC}$ rail under transient loading.

TIMEBASE: 200µs/DIV
NOTE: ALL SIGNALS AT 50mV/DIV UNLESS OTHERWISE STATED
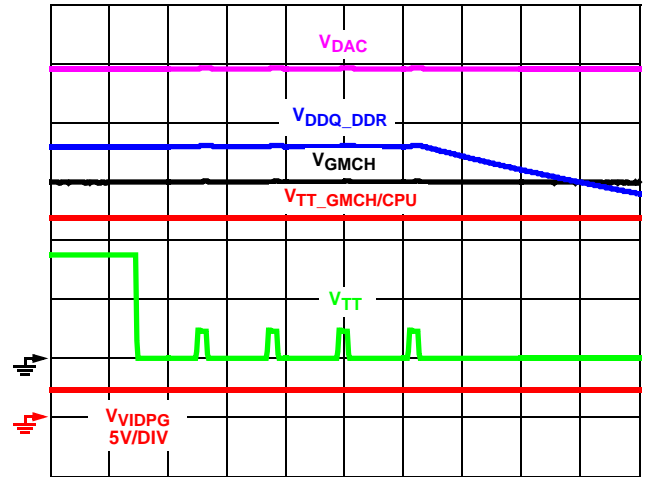**FIGURE 15. TRANSIENT ON V$_{DAC}$**

Fault Protection

Figures 16, 17, 18, 19 and 20 show the response of the system to a shorts on the V$_{DDQ\_DDR}$ rail, V$_{TT}$, rail, V$_{GMCH}$ rail, V$_{TT\_GMCH/CPU}$ rail and V$_{DAC}$ rail, respectively.

TIMEBASE: 50ms/DIV

NOTE: ALL SIGNALS AT 500mV/DIV UNLESS OTHERWISE STATED
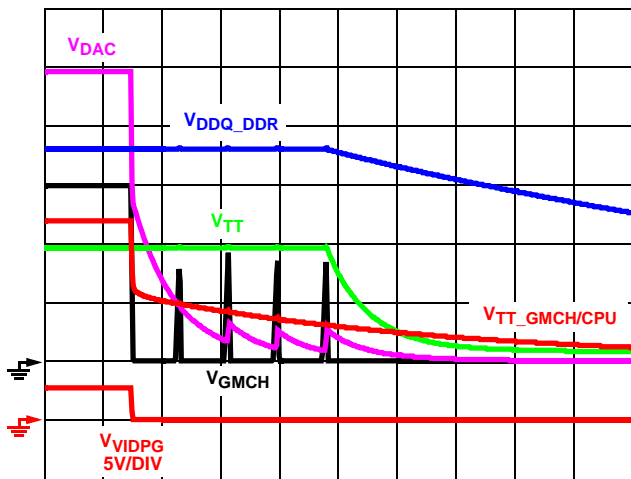100Ω LOAD ON ALL RAILS

FIGURE 16. FAULT RESPONSE ON VDDQ

TIMEBASE: 50ms/DIV

NOTE: ALL SIGNALS AT 500mV/DIV UNLESS OTHERWISE STATED
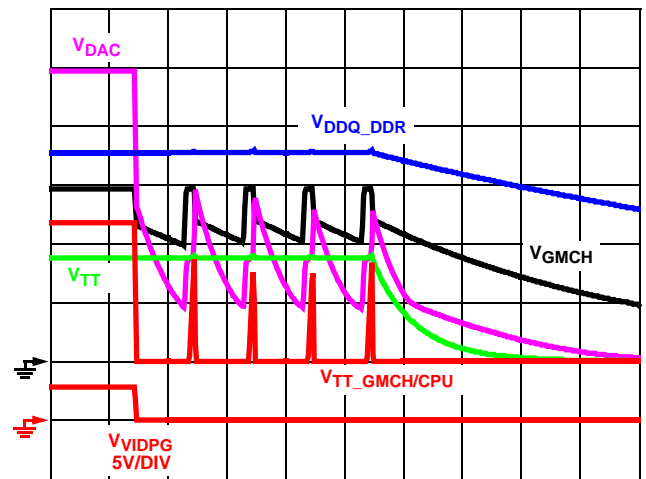100Ω LOAD ON ALL RAILS

FIGURE 17. FAULT RESPONSE ON VTT

TIMEBASE: 50ms/DIV

NOTE: ALL SIGNALS AT 500mV/DIV UNLESS OTHERWISE STATED
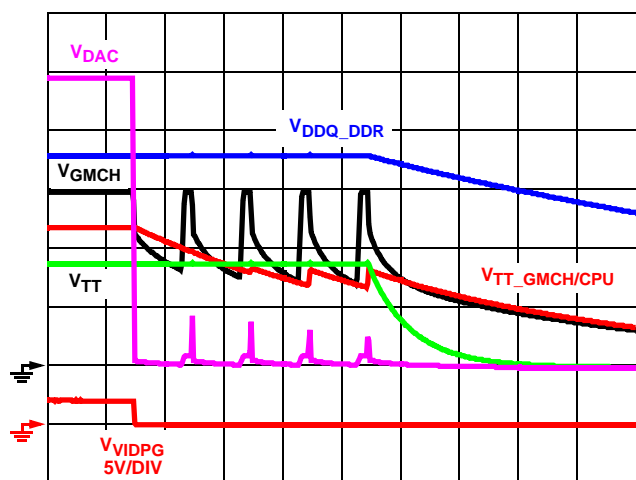100Ω LOAD ON ALL RAILS

FIGURE 18. FAULT RESPONSE ON VGMCH

TIMEBASE: 50ms/DIV

NOTE: ALL SIGNALS AT 500mV/DIV UNLESS OTHERWISE STATED
100Ω LOAD ON ALL RAILS

FIGURE 19. FAULT RESPONSE ON VTT_GMCH/CPU

TIMEBASE: 50ms/DIV
NOTE: ALL SIGNALS AT 500mV/DIV UNLESS OTHERWISE STATED
100Ω LOAD ON ALL RAILS

FIGURE 20. FAULT RESPONSE ON VDAC

FIGURE 21. SWITCHING REGULATOR EFFICIENCIES

Efficiency

Figure 21 shows the efficiencies of the V_{DDQ_DDR} and the V_{GMCH} switching regulators while in the S0 State. Measurements were taken at room temperature under thermal equilibrium with no air flow. As the other regulated outputs are all derived through linear regulation, their efficiencies are not shown.

ISL6548A_6506EVAL1Z Customization

There are numerous ways in which a designer might modify the ISL6548A_6506EVAL1Z evaluation board for differing requirements. Some of the changes which are possible include:

- The input and output inductors, L200 and L201, for the V_{DDQ_DDR} regulator as well as the output inductor, L302, for the V_{GMCH} regulator.

- The input and output capacitance for any of the regulators.

- The overcurrent trip point of the V_{DDQ_DDR} regulator, programmed through the OCSET resistor, R200. Refer to the ISL6548A datasheet for details on this.

- Changing the value of C104 to alter the soft-start profile of the V_{TT_DDR} rail when transitioning from Sleep to Active State.

- All MOSFET footprints on the evaluation board allow for either SO8 or PowerPak packaged MOSFETs to be utilized.

- ISL6506 control can be bypassed by placing zero ohm jumpers at locations R15 and R18. Doing this will short out the NFETs that control the 3VDUAL and 5VDUAL rails.

- The output voltage of any regulator, except for V_{TT_DDR} may be modified by changing the voltage programming
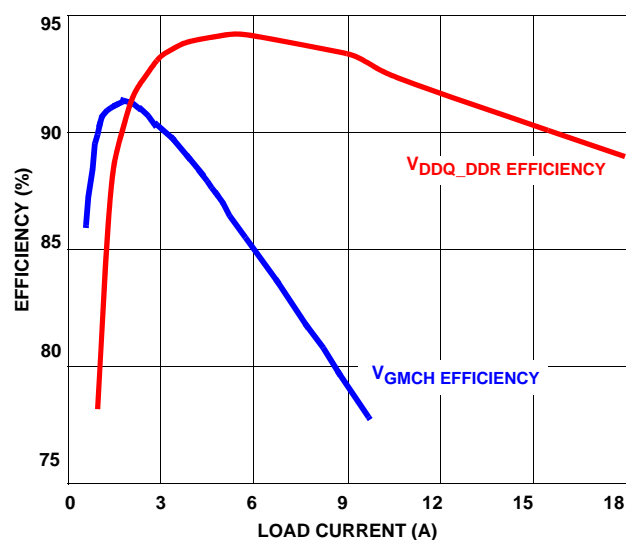
resistor for the respective regulator. For V_{DDQ_DDR}, change R204; for V_{GMCH}, change R303; for V_{DAC}, change R302; $V_{TT\_GMCH/CPU}$, change R401. If the voltage level is to be modified, always change the resistor that is tied between the feedback point of the error amplifier and ground. Modifying the value of the resistor that is located between the output and the feedback point on the error amplifier will alter the system response characteristics. Refer to the ISL6548A datasheet section titled "References" on page 10 for the equations used to select the resistor values discussed above.

- The effect of the S3# and S5# signals on the ATX power supply can be negated by populating resistor Rx11 with a 0Ω jumper. Doing this will cause the PSON# signal to the ATX supply to be hard tied to ground. This will force the ATX supply on even in sleep states.

Conclusion

The ISL6548A_6506EVAL1Z is a versatile platform that allows designers to gain a full understanding of the functionality of the ISL6506 and ISL6548A chipset in an ACPI compliant system. The board is also flexible enough to allow the designer to modify the board for differing requirements. The following pages provide a schematic, bill of materials, and layout drawings to support implementation of this solution.

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References

For Intersil documents available on the web, see
http://www.intersil.com/

[1] *ISL6548A Data Sheet,* Intersil Corporation, FN9189.

[2] *ISL6506 Data Sheet*, Intersil Corporation, FN9141.

[3] *Designing Stable Compensation Networks for Single Phase Voltage Mode Buck Regulators*, Intersil Corporation, TB417.

[4] *Advanced Configuration and Power Interface Specification, Revision 3.0a*, Hewlett Packard, Intel, Microsoft, Phoenix Technologies and Toshiba Corporations.

[5] *ATX Specification, Version 2.2*, Intel Corporation

ISL6548A_6506EVAL1Z Schematic
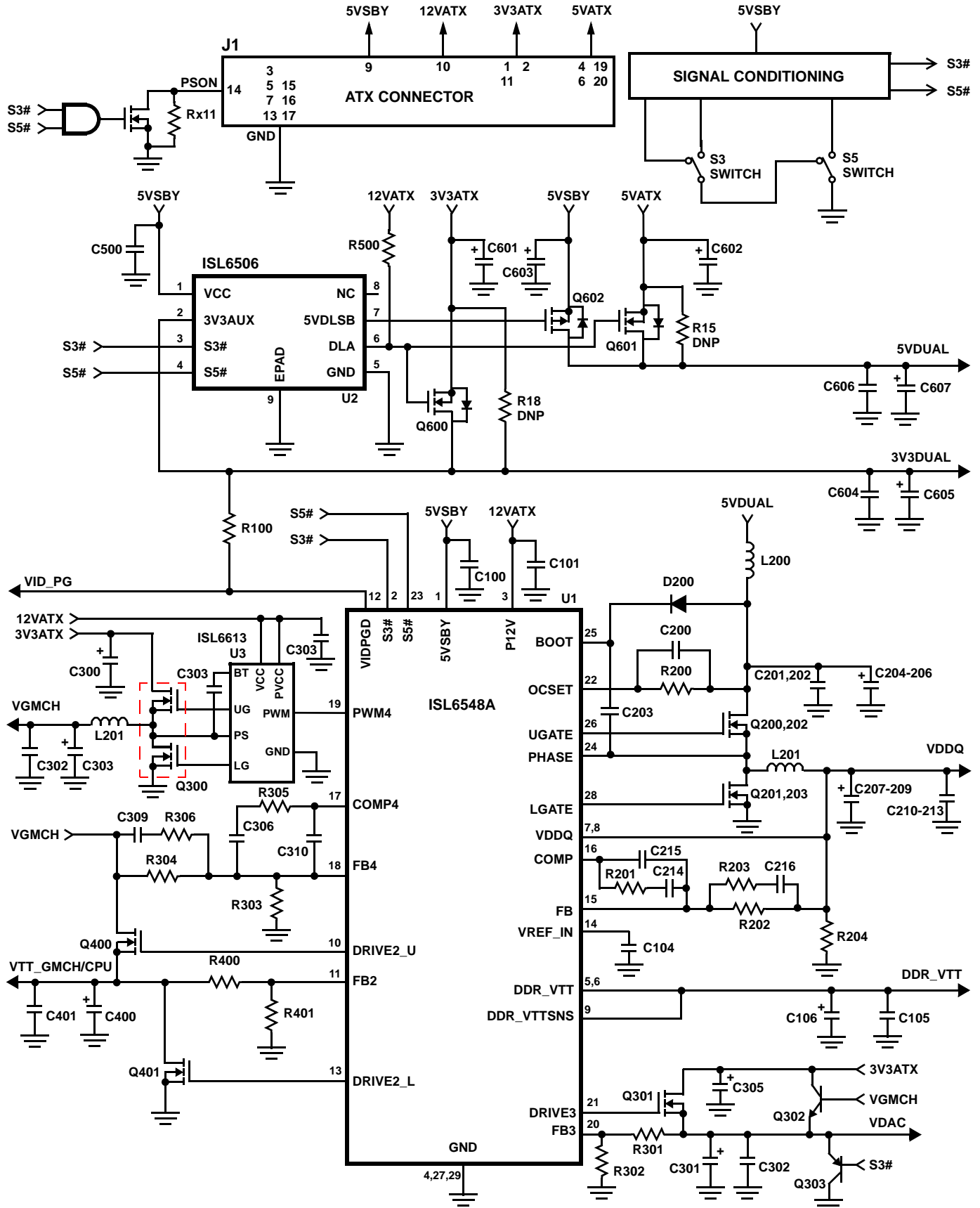
ISL6548A_6506EVAL1Z *Bill of Material*

REF DES	DESCRIPTION	PKG	VENDOR	VENDOR P/N	QTY
C100, 101, 201, 202, 307, 308	1µF, X5R Capacitor	0603	Various		6
C204-206	2200µF 6.3V MBZ Capacitor	10x20	Rubycon	6.3MBZ2200M10X20	3
C207, 208, 209, 301, 304, 400, 605, 607	1800µF 16V MBZ Capacitor	10x23	Rubycon	16MBZ1800M10X23	8
C106, 300, 305, 601, 602, 603	220µF, 25V	8x11.5	Panasonic	EEU-FCIE221	6
C105, 210-213, 302, 304, 401, 500, 604, 606	22µF Capacitor	1206	Various		11
C203, 317	0.1µF Capacitor	0603	Various		2
C104	0.47µF, 10V, X5R MLC Capacitor	0603	TDK	C1608X5R1A474K	1
C200	1000pF, X7R Capacitor	0603	Various		1
C214	4700pF, X7R Capacitor	0603	Various		1
C215	1500pF, X7R Capacitor	0603	Various		1
C216	56nF, X7R Capacitor	0603	Various		1
C306	10nF, X7R Capacitor	0603	Various		1
C309	33nF, X7R Capacitor	0603	Various		1
C310	3300pF, X7R Capacitor	0603	Various		1
D200	Diode		Various	MA732	1
L200, 201, 302	2.1µH, 2mΩ Inductor 7T 14AWG on T50-52B Core		Various		3
Q200-203, 301, 400, 401, 600	30V N-Channel MOSFET	PowerPak	Vishay	Si7840BDP	8
Q300	30V Dual N-Channel MOSFET	PowerPak	Vishay	Si7844BDP	1
Q601	30V N-Channel MOSFET	PowerPak	Vishay	Si7880BDP	1
Q602	30V P-Channel MOSFET	PowerPak	Vishay	Si7483BDP	1
R100	10.0kΩ, 1% Resistor	0603	Various		1
R200	5.76kΩ, 1% Resistor	0603	Various		1
R201	31.6kΩ, 1% Resistor	0603	Various		1
R202, 301, 304	1.74kΩ, 1% Resistor	0603	Various		3
R203	21.0Ω, 1% Resistor	0603	Various		1
R204	1.37kΩ, 1% Resistor	0603	Various		1
R302	1.40kΩ, 1% Resistor	0603	Various		1
R303	1.96kΩ, 1% Resistor	0603	Various		1
R305	18.2kΩ, 1% Resistor	0603	Various		1
R306	36.5Ω, 1% Resistor	0603	Various		1
R309, 310	0Ω Jumper	0603	Various		1
R400	1.24kΩ, 1% Resistor	0603	Various		1
R401	2.43kΩ, 1% Resistor	0603	Various		1
R500	1.00kΩ, 1% Resistor	0603	Various		1
U1	ACPI Compliant DDR, GMCH Regulator	28 Ld 6x6mm QFN	Intersil	ISL6548ACR	1
U2	ACPI Controller	8 Ld ESOIC	Intersil	ISL6506ECB	1
U3	MOSFET Gate Driver	8 Ld SOIC	Intersil	HIP6603BCB	1

ISL6548A_6506EVAL1 Layout

FIGURE 22. TOP SILK SCREEN

FIGURE 23. TOP

ISL6548A_6506EVAL1 Layout (Continued)
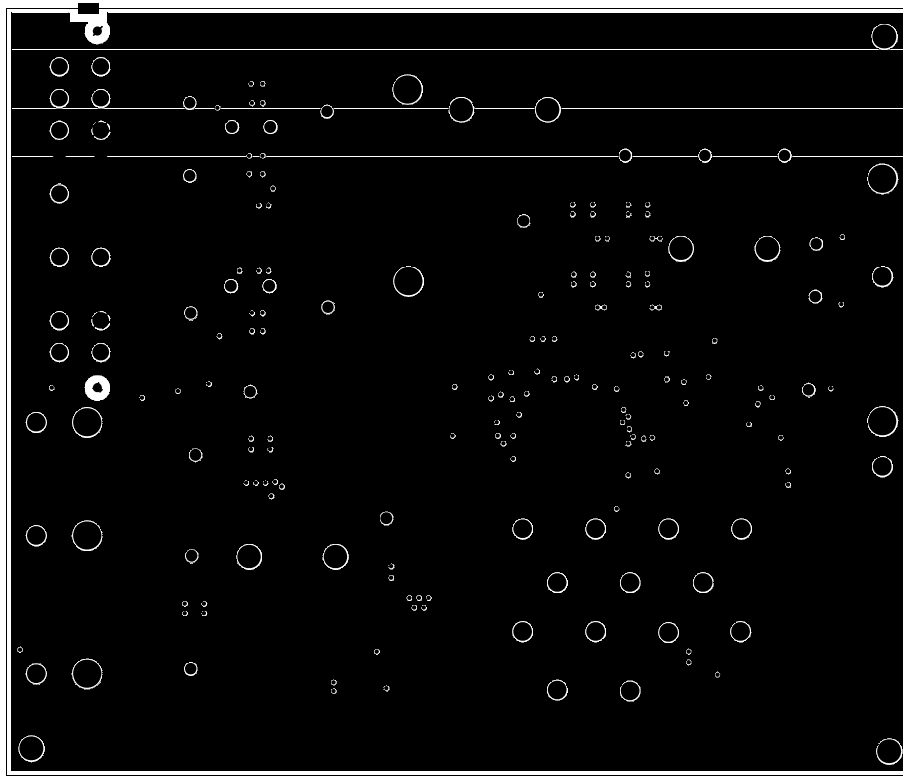
FIGURE 24. INTERNAL 1 GROUND

FIGURE 25. INTERNAL 2 POWER

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ISL6548A_6506EVAL1 Layout (Continued)
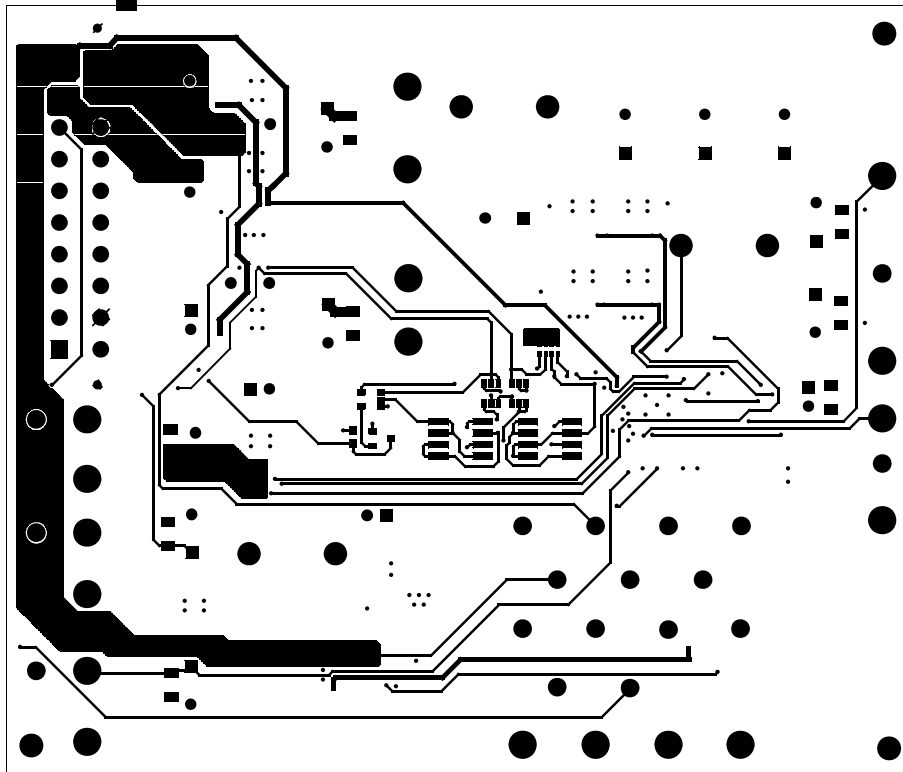
FIGURE 26. BOTTOM
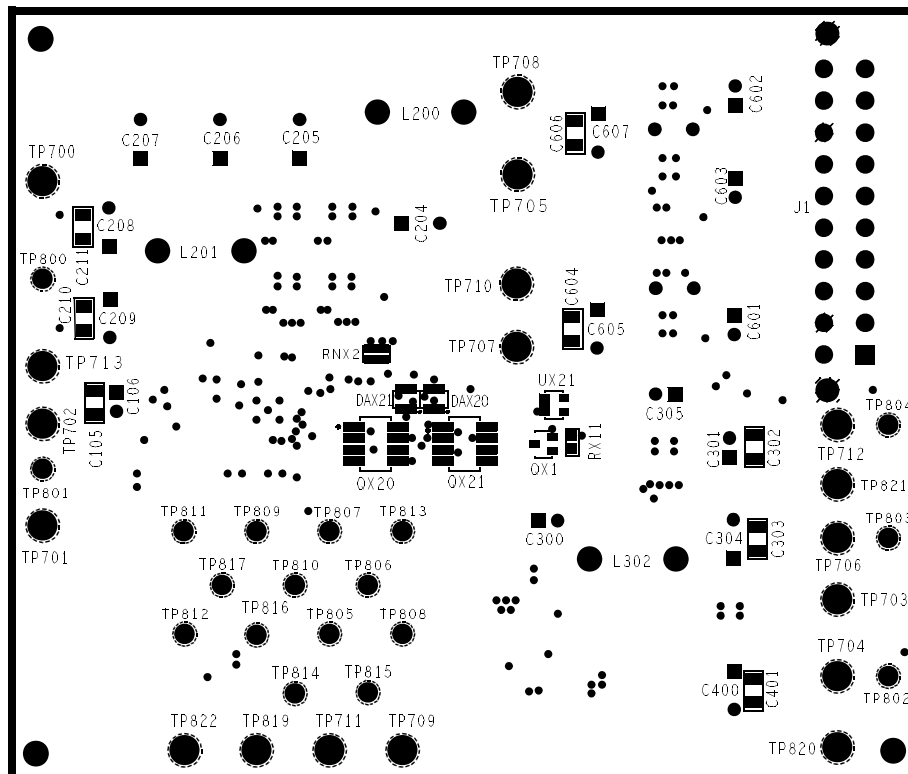
FIGURE 27. BOTTOM SILK SCREEN (*REVERSED*)

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